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Qualification Description	Qualification of RFSA2644 for production.					
Package Type	4.2 mm x 4.2 mm Module	Process Technology	GaAs pHEMT / Si CMOS			
Qualification #	11-QUAL-1594	Date Issued	March 29, 2012			

Qualification Description

The purpose of the qualification outlined in this document is to ensure that the RFSA2644 is a reliable product and meets the RFMD requirements for product quality.

Qualification Methodology

The RFMD qualification process consists of a series of tests designed to stress various potential failure mechanisms. The testing is performed to ensure that RFMD's products are robust against potential failure modes that could arise from the various failure mechanisms being stressed. The qualification testing is based on JEDEC and MIL-STD test methods common to the semiconductor industry. Where applicable, qualification data taken on similar devices is used to demonstrate that the qualification requirements will be met.

Qualification Results

The RFSA2644 has passed all of the defined qualification requirements listed below and has been qualified as a reliable product. The RFSA2644 has been subjected to various device level and package level tests and has demonstrated reliable performance. The qualification test results are listed in the table below.



RFSA2644 Qualification Report

Qualification Tests

Qualification Tests Test Name Test Standard and Conditions # Samples x Test Results								
Test Name	Test Standard and Conditions	# Lots	Test Results					
Temperature Characterization	JESD86 +25°C, -40°C, +85°C	2 x 3 lots	Pass					
High Temperature Operating Life	JESD22-A108 125°C, 1000 hours	77 x 3 lots	Pass					
Steady State Temperature Humidity Bias Life Test	JESD22-A101 +85°C, 85%RH, 500 hours Preconditioning per JESD22-A113 MSL3	24 x 3 lots	Pass					
ESD Human Body Model	JESD22-A114	3 x 1 lot	Pass 1000V Class 1C		Class 1C			
ESD Charged-Device Model	JESD22-C101	3 x 1 lot	Pass 1000V Class I		Class IV			
IC Latch Up	JESD78 Class I : +25°C Level A : ±100 mA	6x 1 lot	Pass					
Moisture Sensitivity Level Classification	J-STD-20 MSL3 30°C, 60% RH, 192 Hour Soak 3x Reflow at 260°C	25 x 3 lots	Pass	MSL3	260°C			
Temperature Cycling	JESD22-A104 Test Condition G : -40°C to +125°C 500 cycles Preconditioning per JESD22-A113 MSL3	25 x 3 lots	Pass					
Temperature Cycling on Board	JESD22-A104 Test Condition G : -40°C to +125°C 500 cycles Preconditioning per JESD22-A113 MSL3	22 x 3 lots	Pass					
High Temperature Storage Life	JESD22-A103 150°C, 1000 Hours	22 x 3 lots	Pass					
Die Shear	MIL-STD-883, Method 2019 minimum 671 g, 972 g	10 x 3 lots	Pass					
Ball Shear	JESD22-B116 minimum 15 g, 20g	10 x 3 lots	Pass					
Bond Pull	MIL-STD-883, Method 2011 minimum 3 g	10 x 3 lots	Pass					
Solderability	JESD22-B102 Condition C : 8 Hour Steam Precondition Pb-Free Process Method 1 : Dip and Look	22 x 3 lots	Pass					
Conclusion	This product has passed the RI	FMD Qualification F	Requirement	s for produ	uction.			